

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## **Small Signal Product**

# 350mW, SMD Switching Diode

### **FEATURES**

- Fast switching speed
- Surface mount device type
- Moisture sensitivity level 1
- Matte Tin (Sn) lead finish with Nickel (Ni) underplate
- Pb free version and RoHS compliant
- Packing code with suffix "G" means green compound (halogen-free)





**SOT-23** 



#### **MECHANICAL DATA**

- Case: SOT-23 small outline plastic package
- Terminal: Matte tin plated, lead free., solderable per MIL-STD-202, Method 208 guaranteed
- High temperature soldering guaranteed : 260°C/10s
- Weight: 8 ± 0.5 mg

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)				
PARAM	ETER	SYMBOL	VALUE	UNIT
Power Dissipation		P <sub>D</sub>	350	mW
Repetitive Peak Reverse Voltage		$V_{RRM}$	350	V
Repetitive Peak Forward Current		I <sub>FRM</sub>	625	mA
Mean Forward Current		I <sub>O</sub>	225	mA
Non-Repetitive Peak Forward	Pulse Width=1µs	1	4	^
Surge Current	Pulse Width=1s	<sup>I</sup> FSM	1	A
Thermal Resistance (Junction to Ambient)		$R_{ heta JA}$	357	°C/W
Junction and Storage Temperature Range		$T_J, T_{STG}$	-65 to +150	°C

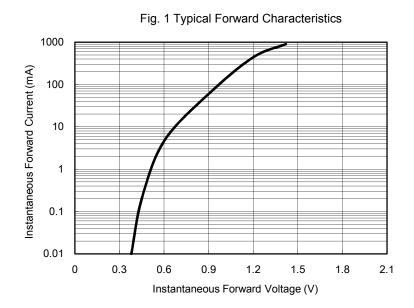
P.A	RAMETER	SYMBOL	MIN	MAX	UNIT
Reverse Breakdown Voltage	I <sub>R</sub> =100μA	$V_{(BR)}$	350	-	V
Forward Voltage	I <sub>F</sub> =100mA	V <sub>F</sub>	-	1.00	V
	I <sub>F</sub> =200mA	VF	-	1.25	
Reverse Leakage Current	V <sub>R</sub> =240V	1	-	0.1	μA
	$V_R = 240V$ , $T_J = 150$ °C	I <sub>R</sub>	-	100	
Junction Capacitance	V <sub>R</sub> =1V, f=1.0MHz	CJ	-	5	pF
Reverse Recovery Time	$I_F = I_R = 30 \text{mA}, R_L = 100 \Omega, I_{RR} = 0.1 I_R$	t <sub>rr</sub>	-	50	ns

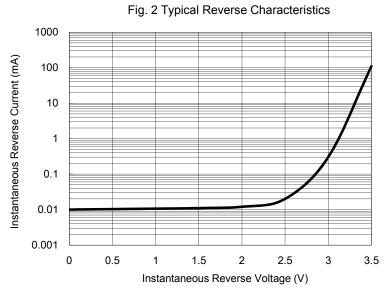


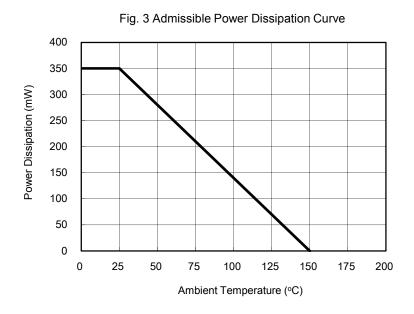
## **Small Signal Product**

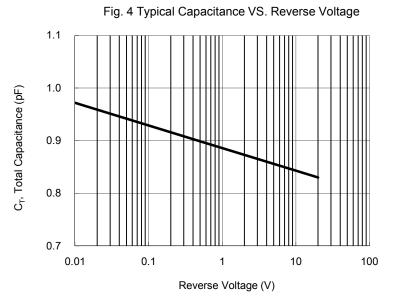
#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)





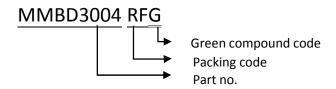






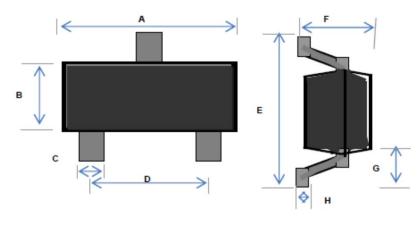
## **Small Signal Product**

# ORDER INFORMATION (EXAMPLE)



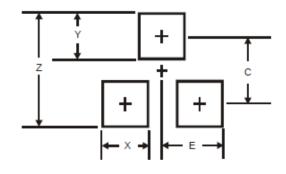
# PACKAGE OUTLINE DIMENSIONS

### **SOT-23**



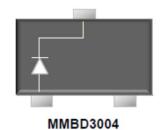
DIM.	Unit (mm)		Unit (inch)	
DIIVI.	Min	Max	Min	Max
Α	2.70	3.10	0.106	0.122
В	1.10	1.50	0.043	0.059
С	0.30	0.51	0.012	0.020
D	1.78	2.04	0.070	0.080
Е	2.10	2.64	0.083	0.104
F	0.89	1.30	0.035	0.051
G	0.55 REF		0.022 REF	
Н	0.10 REF		0.004 REF	

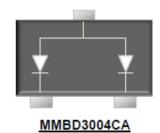
### SUGGEST PAD LAYOUT

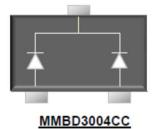


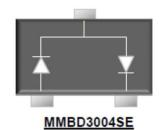
DIM.	Unit (mm)	Unit (inch)
DIN.	Тур.	Тур.
Z	2.8	0.110
Χ	0.7	0.028
Υ	0.9	0.035
С	1.9	0.075
E	1.0	0.039

### **PIN CONFIGURATION**









**MARKING** 

Part No.	Marking
MMBD3004	HC
MMBD3004CA	RA
MMBD3004CC	PZ
MMBD3004SE	PY

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Taiwan Semiconductor



**Small Signal Product** 

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